

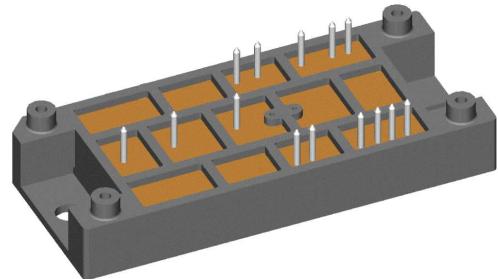
# Standard Rectifier Module

3~ Rectifier	Brake Chopper
$V_{RRM} = 1600 \text{ V}$	$V_{CES} = 1200 \text{ V}$
$I_{DAV} = 180 \text{ A}$	$I_{C25} = 180 \text{ A}$
$I_{FSM} = 1100 \text{ A}$	$V_{CE(sat)} = 1.7 \text{ V}$

## 3~ Rectifier Bridge + Brake Unit

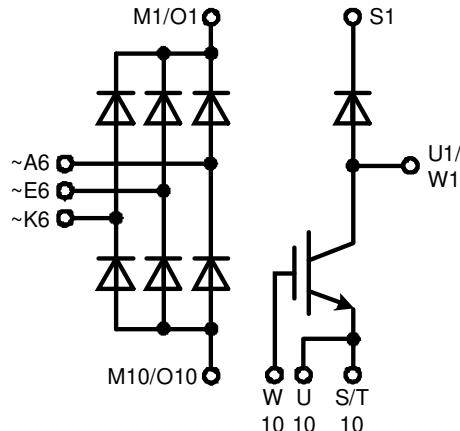
Part number

**VUB120-16NOX**



Backside: isolated

 E72873



### Features / Advantages:

- Package with DCB ceramic base plate
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current
- X2PT - 2nd generation Xtreme light Punch Through
- Rugged X2PT design results in:
  - short circuit rated for 10  $\mu\text{sec}$ .
  - very low gate charge
  - low EMI
  - square RBSOA @ 2x  $I_c$
- Thin wafer technology combined with X2PT design results in a competitive low  $V_{CE(sat)}$  and low thermal resistance

### Applications:

- 3~ Rectifier with brake unit for drive inverters

### Package: V2-Pack

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Height: 17 mm
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

### Disclaimer Notice

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**Rectifier**

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
$V_{RSM}$	max. non-repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			1700	V
$V_{RRM}$	max. repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			1600	V
$I_R$	reverse current	$V_R = 1600 V$ $V_R = 1600 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		100 2	$\mu A$ mA
$V_F$	forward voltage drop	$I_F = 60 A$	$T_{VJ} = 25^\circ C$		1.16	V
		$I_F = 180 A$			1.55	V
		$I_F = 60 A$	$T_{VJ} = 125^\circ C$		1.09	V
		$I_F = 180 A$			1.59	V
$I_{DAV}$	bridge output current	$T_C = 90^\circ C$ rectangular $d = \frac{1}{3}$	$T_{VJ} = 150^\circ C$		180	A
$V_{F0}$ $r_F$	threshold voltage slope resistance } for power loss calculation only		$T_{VJ} = 150^\circ C$		0.81 4.4	V $m\Omega$
$R_{thJC}$	thermal resistance junction to case				0.6	K/W
$R_{thCH}$	thermal resistance case to heatsink			0.2		K/W
$P_{tot}$	total power dissipation		$T_C = 25^\circ C$		205	W
$I_{FSM}$	max. forward surge current	$t = 10 ms; (50 Hz)$ , sine	$T_{VJ} = 45^\circ C$		1.10	kA
		$t = 8,3 ms; (60 Hz)$ , sine	$V_R = 0 V$		1.19	kA
		$t = 10 ms; (50 Hz)$ , sine	$T_{VJ} = 150^\circ C$		935	A
		$t = 8,3 ms; (60 Hz)$ , sine	$V_R = 0 V$		1.01	kA
$I^2t$	value for fusing	$t = 10 ms; (50 Hz)$ , sine	$T_{VJ} = 45^\circ C$		6.05	$kA^2s$
		$t = 8,3 ms; (60 Hz)$ , sine	$V_R = 0 V$		5.89	$kA^2s$
		$t = 10 ms; (50 Hz)$ , sine	$T_{VJ} = 150^\circ C$		4.37	$kA^2s$
		$t = 8,3 ms; (60 Hz)$ , sine	$V_R = 0 V$		4.25	$kA^2s$
$C_J$	junction capacitance	$V_R = 400 V; f = 1 MHz$	$T_{VJ} = 25^\circ C$	37		pF

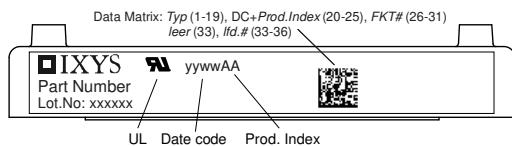
**Brake IGBT + Diode**

Symbol	Definition	Conditions	Ratings				
			min.	typ.	max.		
$V_{CES}$	collector emitter voltage	$T_{VJ} = 25^\circ C$			1200	V	
$V_{GES}$	max. DC gate voltage				$\pm 20$	V	
$V_{GEM}$	max. transient gate emitter voltage				$\pm 30$	V	
$I_{C25}$	collector current	$T_C = 25^\circ C$			180	A	
$I_{C80}$		$T_C = 80^\circ C$			140	A	
$P_{tot}$	total power dissipation	$T_C = 25^\circ C$			500	W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 100 A; V_{GE} = 15 V$	$T_{VJ} = 25^\circ C$	1.7	2.1	V	
			$T_{VJ} = 125^\circ C$	1.9		V	
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 4 mA; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ C$	6	6.8	7.5	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 V$	$T_{VJ} = 25^\circ C$		0.1	mA	
			$T_{VJ} = 125^\circ C$	0.1		mA	
$I_{GES}$	gate emitter leakage current	$V_{GE} = \pm 20 V$			500	nA	
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 V; V_{GE} = 15 V; I_C = 100 A$		340		nC	
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600 V; I_C = 100 A$ $V_{GE} = \pm 15 V; R_G = 6.8 \Omega$	$T_{VJ} = 125^\circ C$	230		ns	
$t_r$	current rise time			70		ns	
$t_{d(off)}$	turn-off delay time			380		ns	
$t_f$	current fall time			230		ns	
$E_{on}$	turn-on energy per pulse			12.5		mJ	
$E_{off}$	turn-off energy per pulse			11.5		mJ	
<b>RBSOA</b>	reverse bias safe operating area	$V_{GE} = \pm 15 V; R_G = 6.8 \Omega$	$T_{VJ} = 125^\circ C$				
$I_{CM}$		$V_{CEK} = 1200 V$			300	A	
<b>SCSOA</b>	short circuit safe operating area	$V_{CEK} = 1200 V$					
$t_{sc}$	short circuit duration	$V_{CE} = 720 V; V_{GE} = \pm 15$	$T_{VJ} = 125^\circ C$		10	μs	
$I_{sc}$	short circuit current	$R_G = 6.8 \Omega$ ; non-repetitive		450		A	
$R_{thJC}$	thermal resistance junction to case				0.25	K/W	
$R_{thCH}$	thermal resistance case to heatsink			0.10		K/W	

**Brake Diode**

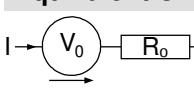
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 25^\circ C$		1200	V
$I_{F25}$	forward current	$T_C = 25^\circ C$		48	A
$I_{F80}$		$T_C = 80^\circ C$		32	A
$V_F$	forward voltage	$I_F = 30 A$	$T_{VJ} = 25^\circ C$	2.75	V
			$T_{VJ} = 125^\circ C$	1.60	V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ C$	0.25	mA
			$T_{VJ} = 125^\circ C$	1	mA
$Q_{rr}$	reverse recovery charge	$V_R = 600 V$ $-di_F/dt = 1000 A/\mu s$ $I_F = 30 A; V_{GE} = 0 V$	$T_{VJ} = 125^\circ C$	5.2	μC
				50	A
				300	ns
				1.9	mJ
$R_{thJC}$	thermal resistance junction to case			0.9	K/W
$R_{thCH}$	thermal resistance case to heatsink			0.3	K/W

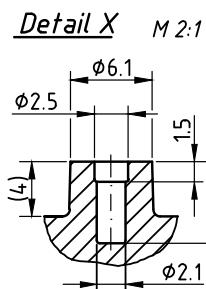
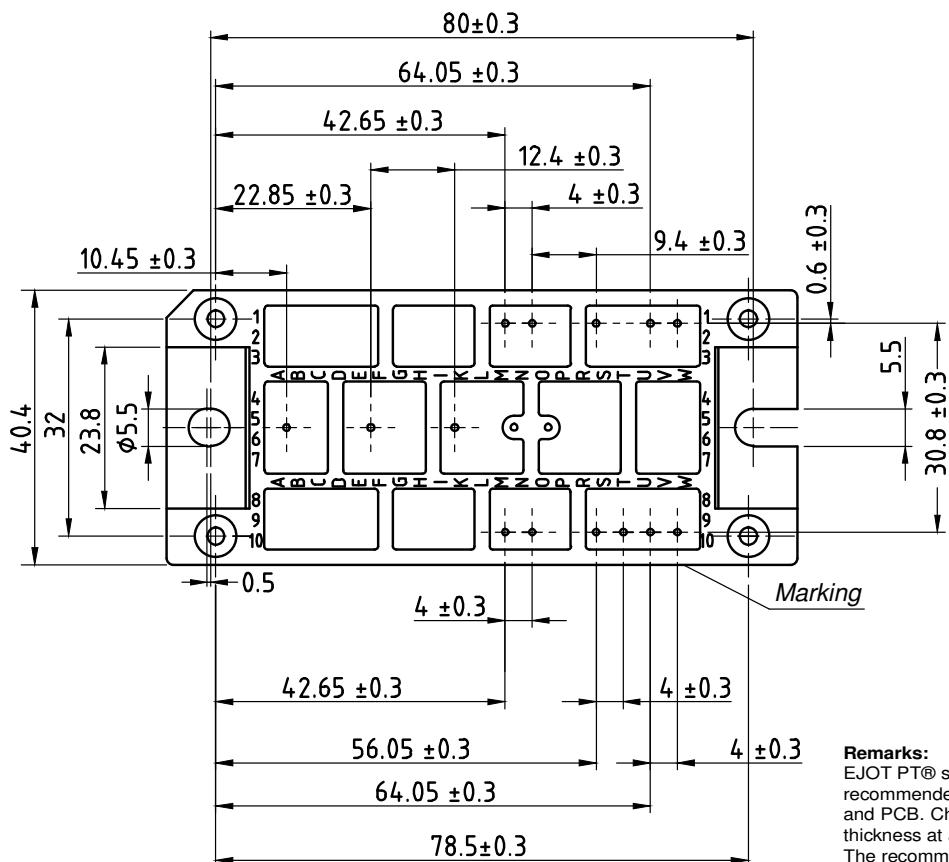
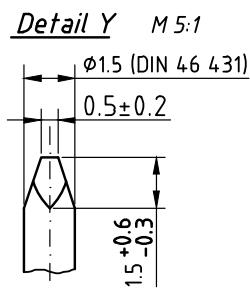
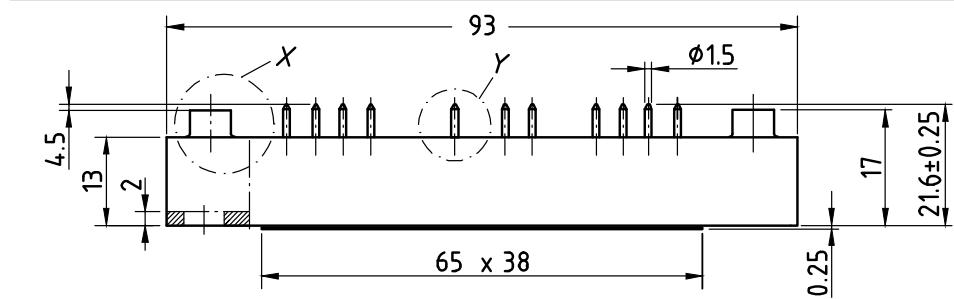
Package V2-Pack			Ratings		
Symbol	Definition	Conditions	min.	typ.	max.
					Unit
$I_{RMS}$	RMS current	per terminal			100 A
$T_{VJ}$	virtual junction temperature		-40		150 °C
$T_{op}$	operation temperature		-40		125 °C
$T_{stg}$	storage temperature		-40		125 °C
<b>Weight</b>				76	g
$M_D$	mounting torque		2		2.5 Nm
$d_{Spp/App}$	creepage distance on surface / striking distance through air		terminal to terminal		6.0 mm
$d_{Spb/Apb}$			terminal to backside		12.0 mm
$V_{ISOL}$	isolation voltage	t = 1 second t = 1 minute	50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA		3600 V 3000 V



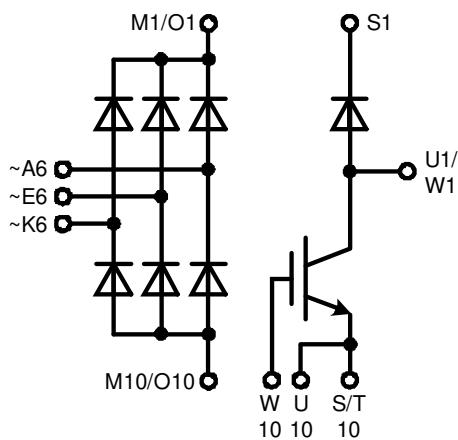
Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	VUB120-16NOX	VUB120-16NOX	Box	6	520475

Similar Part	Package	Voltage class
VUB120-16NOXT	V2-Pack	1600

Equivalent Circuits for Simulation		* on die level	$T_{VJ} = 150^\circ\text{C}$
	Rectifier	Brake Diode	
$V_{0\ max}$	threshold voltage	0.81	1.31 V
$R_{0\ max}$	slope resistance *	3.2	8 mΩ

**Outlines V2-Pack**

**Remarks:**

EJOT PT® self-tapping screws of the dimension K25 are recommended for the mechanical connection between module and PCB. Choose the right length according to your board thickness at a maximum depth of 6 mm of the module holes. The recommended mounting torque is 1.5 Nm.



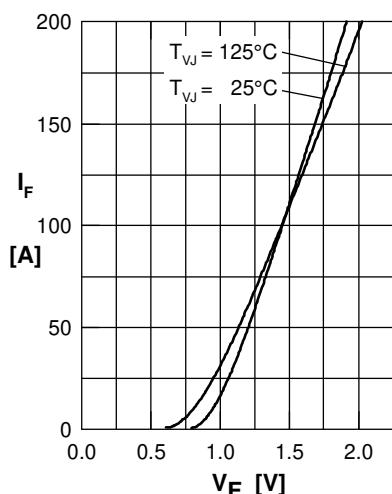
**Rectifier**


Fig. 1 Forward current vs.  
voltage drop per diode

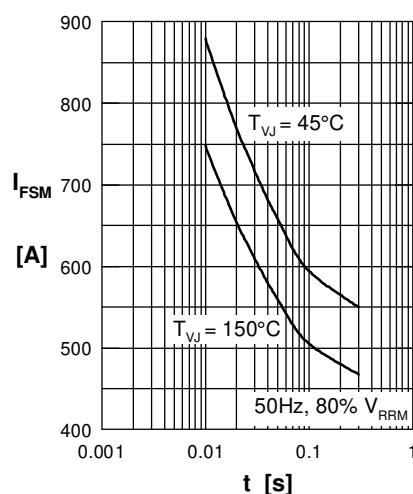


Fig. 2 Surge overload current  
vs. time per diode

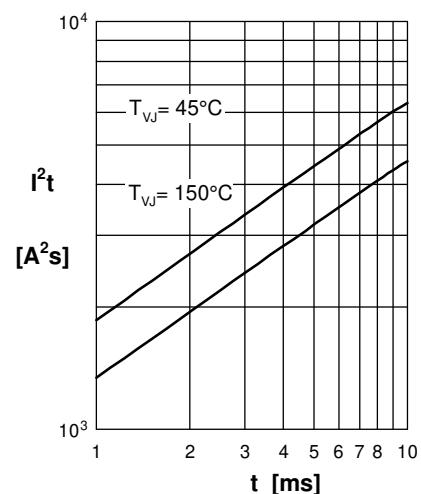


Fig. 3  $I^2t$  vs. time per diode

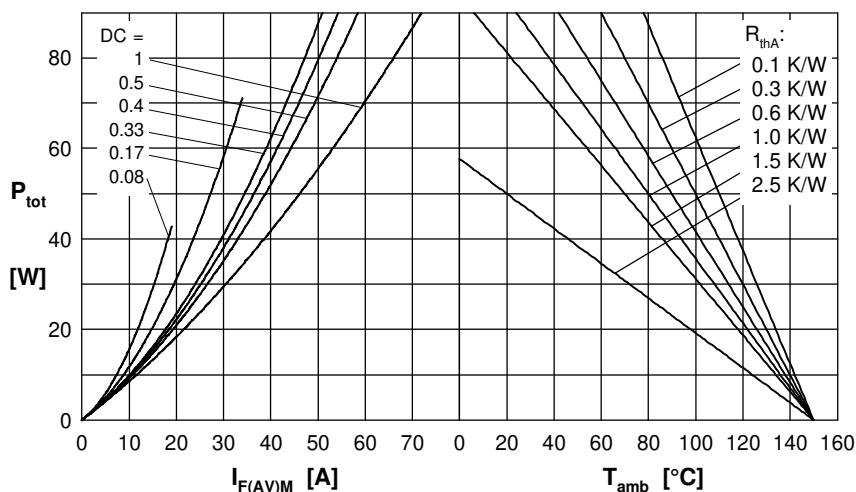


Fig. 4 Power dissipation vs. forward current  
and ambient temperature per diode

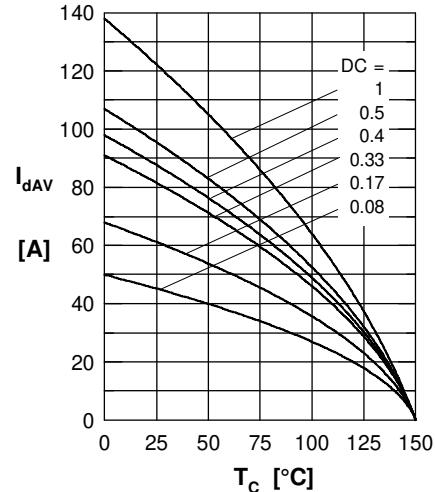


Fig. 5 Max. forward current vs.  
case temperature per diode

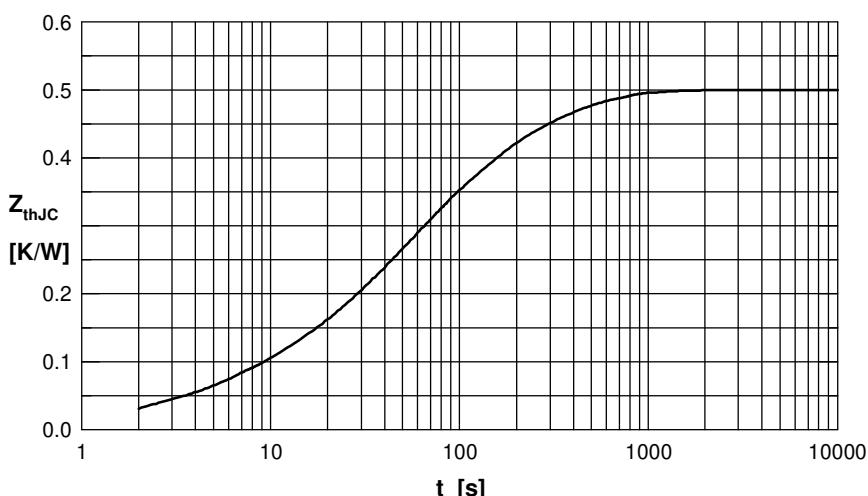


Fig. 6 Transient thermal impedance junction to case vs. time per diode

Constants for  $Z_{thJC}$  calculation:

i	$R_{th}$ (K/W)	$t_i$ (s)
1	0.040	0.004
2	0.003	0.010
3	0.140	0.030
4	0.120	0.300
5	0.197	0.080

### Brake IGBT + Diode

